

### Features

- -100V/-34A,  
 $R_{DS(ON)} = 35m\Omega(Typ.)@V_{GS}=-10V$   
 $R_{DS(ON)} = 40m\Omega(Typ.)@V_{GS}=-4.5V$
- Low  $R_{DS(ON)}$
- Super High Dense Cell Design
- Reliable and Rugged

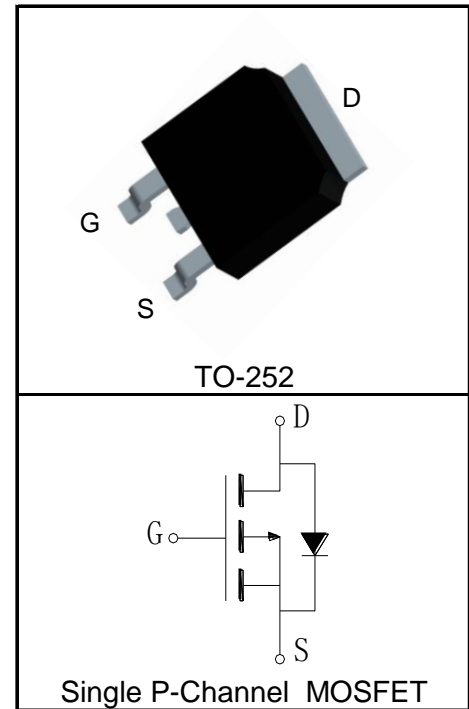
### Applications

- Power Switching Appliaction
- Load Switching



Halogen-Free

### Pin Description



### Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
<b>Common Ratings</b> ( $T_C=25^\circ C$ Unless Otherwise Noted)				
$V_{DSS}$	Drain-Source Voltage	-100	V	
$V_{GSS}$	Gate-Source Voltage	$\pm 20$		
$T_J$	Maximum Junction Temperature	175	$^\circ C$	
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ C$	
$I_S$	Diode Continuous Forward Current	$T_C=25^\circ C$	-34	A
<b>Mounted on Large Heat Sink</b>				
$I_{DP}^{①}$	300 $\mu s$ Pulse Drain Current Tested	$T_C=25^\circ C$	-136	A
$I_D^{②}$	Continuous Drain Current( $V_{GS}=-10V$ )	$T_C=25^\circ C$	-34	A
		$T_C=100^\circ C$	-24	
$P_D$	Maximum Power Dissipation	$T_C=25^\circ C$	100	W
		$T_C=100^\circ C$	50	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	1.5	$^\circ C/W$	
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	100	$^\circ C/W$	
<b>Drain-Source Avalanche Ratings</b>				
$E_{AS}^{④}$	Avalanche Energy, Single Pulsed	169	mJ	

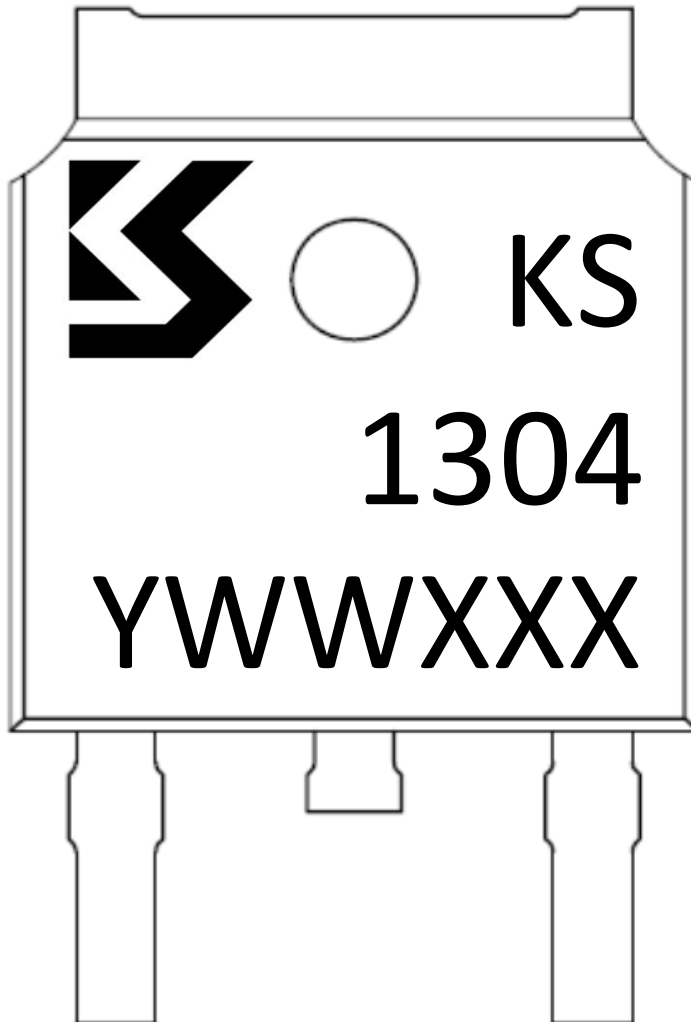
**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Condition	KS1304DB			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=-250\mu A$	-100			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-100V, V_{GS}=0V$			-1	$\mu A$
		$T_J=125^\circ\text{C}$			-30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=-250\mu A$	-1.2	-1.7	-2.3	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$R_{DS(ON)}^{(5)}$	Drain-Source On-state Resistance	$V_{GS}=-10V, I_{DS}=-20A$		35	55	$m\Omega$
		$V_{GS}=-4.5V, I_{DS}=-10A$		40	65	$m\Omega$
<b>Diode Characteristics</b>						
$V_{SD}^{(5)}$	Diode Forward Voltage	$I_{SD}=-20A, V_{GS}=0V$		-0.86	-1.2	V
$t_{rr}$	Reverse Recovery Time	$I_{SD}=-20A, dI_{SD}/dt=-100A/\mu s$		48		ns
$Q_{rr}$	Reverse Recovery Charge			155		nC
<b>Dynamic Characteristics<sup>(6)</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$		8		$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=-50V,$ Frequency=1.0MHz		5050		pF
$C_{oss}$	Output Capacitance			200		
$C_{rss}$	Reverse Transfer Capacitance			155		
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=-50V, I_{DS}=-20A,$ $V_{GEN}=-10V, R_G=3\Omega$		18		ns
$t_r$	Turn-on Rise Time			32		
$t_{d(OFF)}$	Turn-off Delay Time			78		
$t_f$	Turn-off Fall Time			41		
<b>Gate Charge Characteristics<sup>(6)</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=-50V, V_{GS}=-10V,$ $I_{DS}=-20A$		79		nC
$Q_{gs}$	Gate-Source Charge			14		
$Q_{gd}$	Gate-Drain Charge			18		

- Notes:
- ① Pulse width limited by safe operating area.
  - ② Calculated continuous current based on maximum allowable junction temperature.
  - ③ When mounted on 1 inch square copper board,  $t \leq 10\text{sec}$ . The value in any given application depends on the user's specific board design.
  - ④ Limited by  $T_{Jmax}, I_{AS} = -26A, L=0.5\text{mH}, V_{DD} = -48V, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$ .
  - ⑤ Pulse test; Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
  - ⑥ Guaranteed by design, not subject to production testing.

**Ordering and Marking Information**

Device	Package	Packaging	Quantity	Reel Size	Tape width
KS1304DB	TO-252	Tape&Reel	2500	13"	16mm

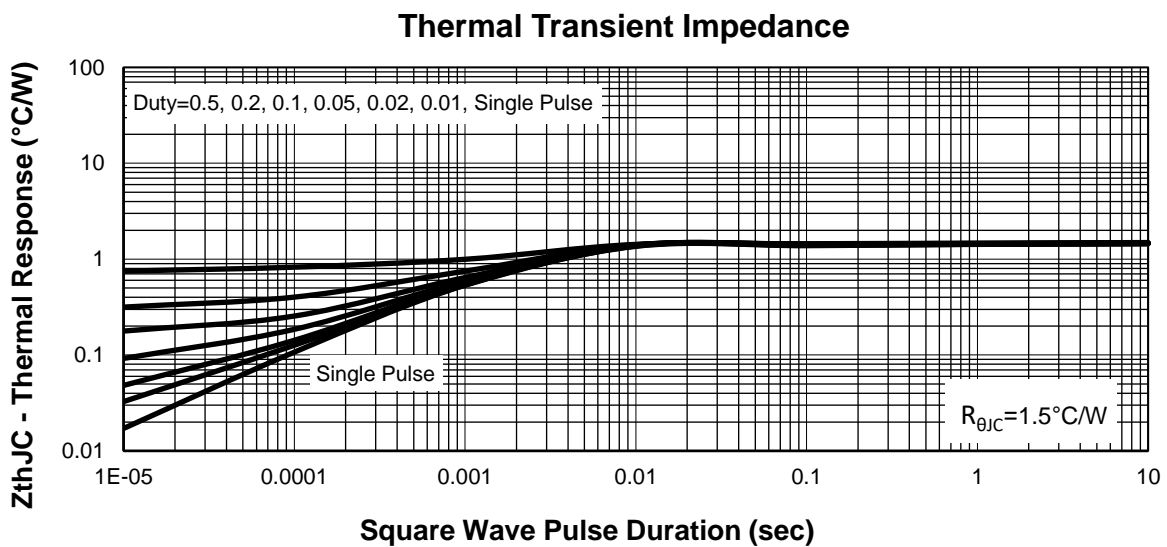
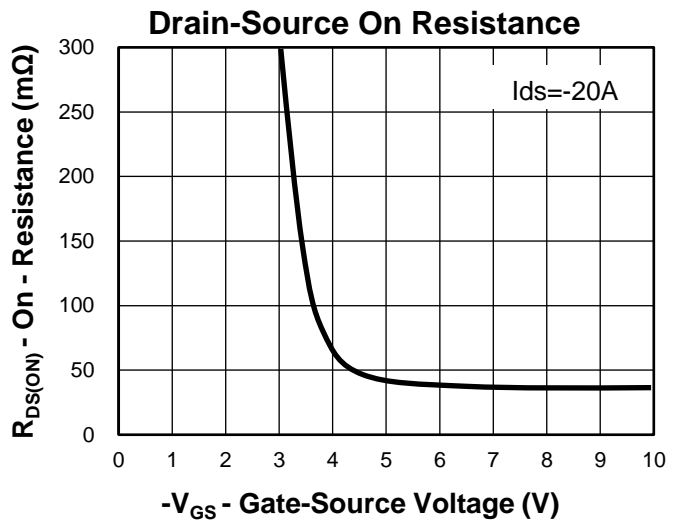
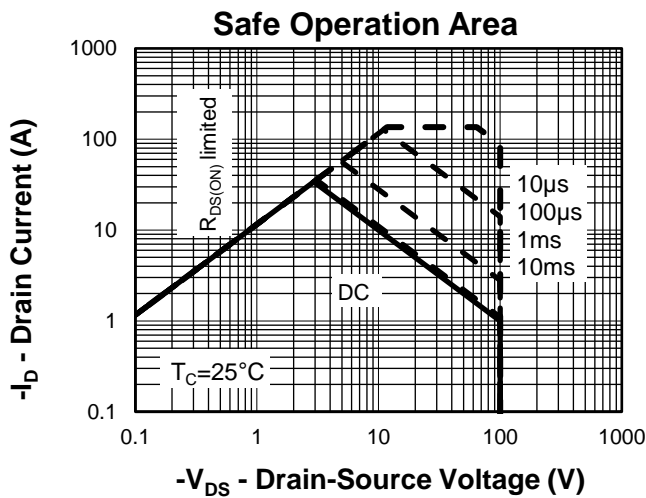
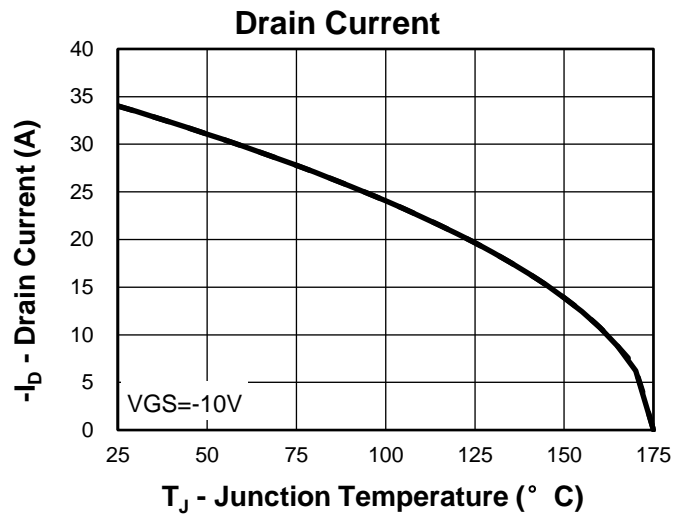
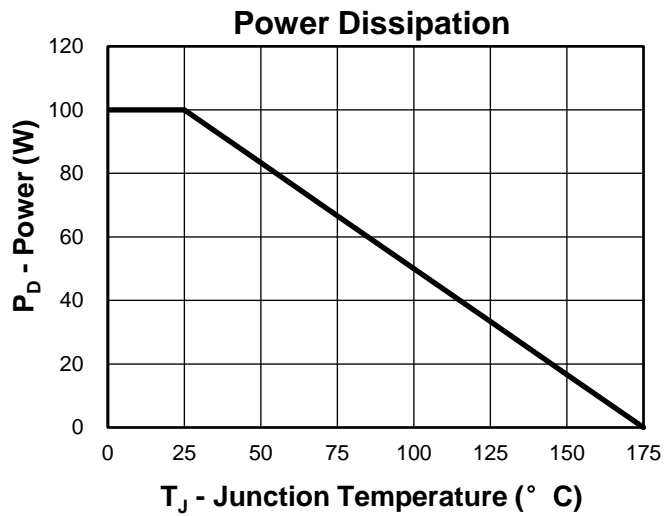


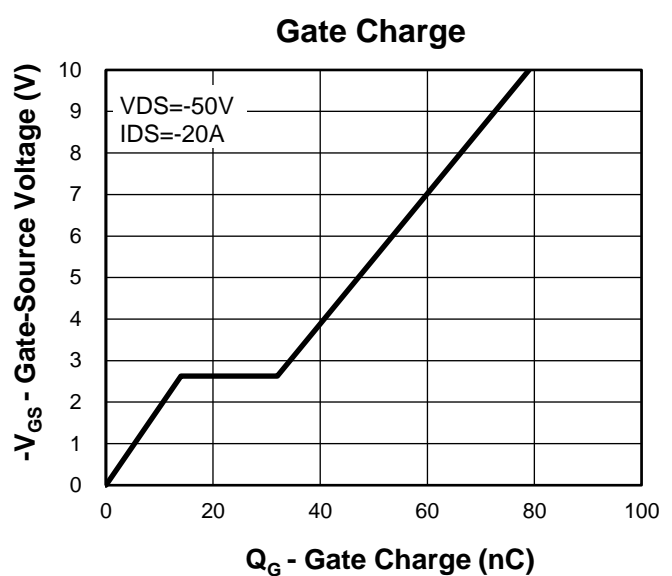
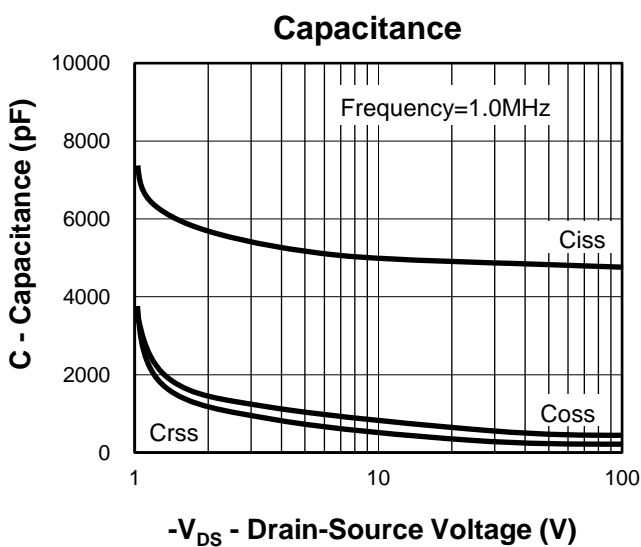
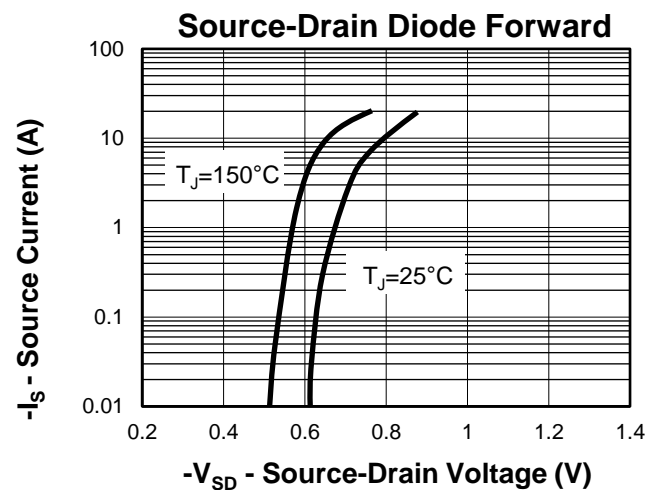
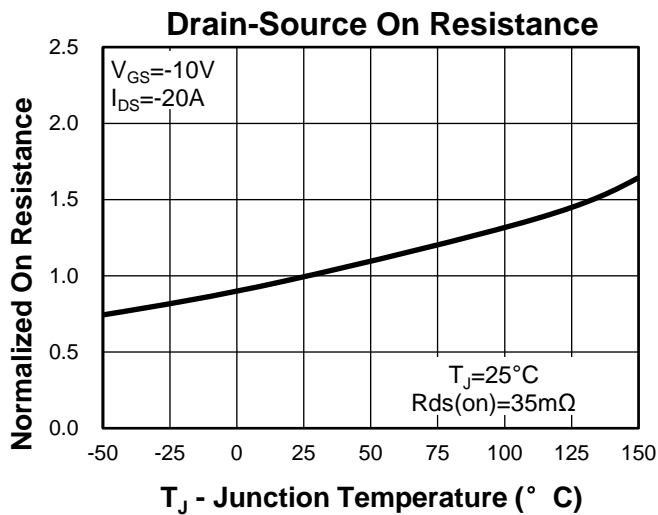
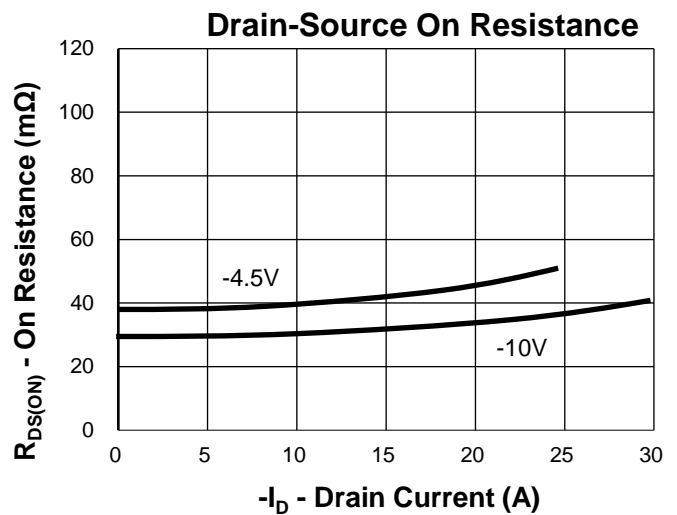
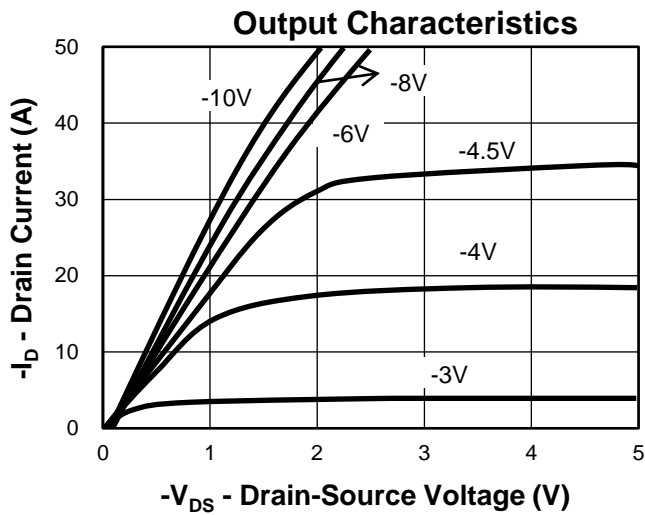
1st Line: Kwansemi LOGO, Kwansemi Code(KS)

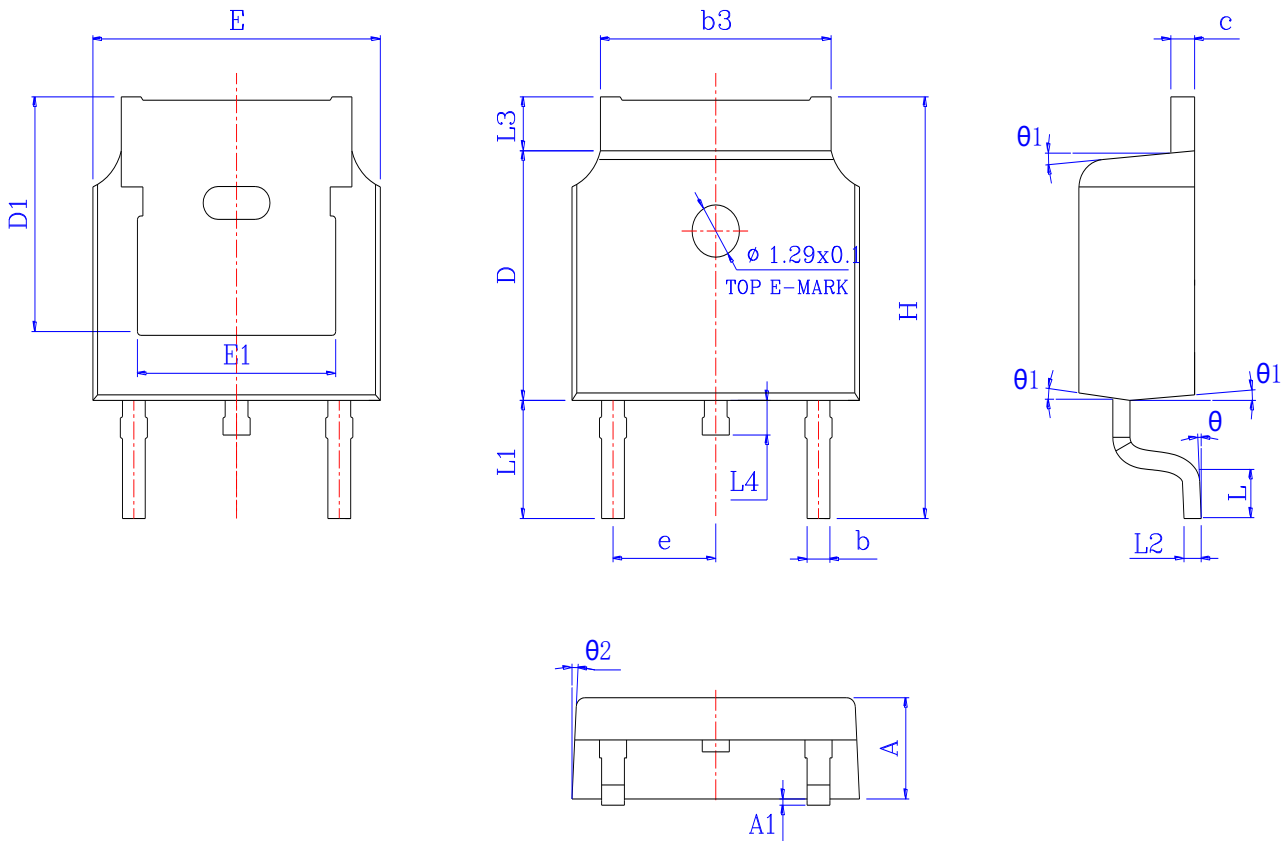
2nd Line: Part Number(1304)

3rd Line: Lot Number(YWWXXX)

### Typical Characteristics

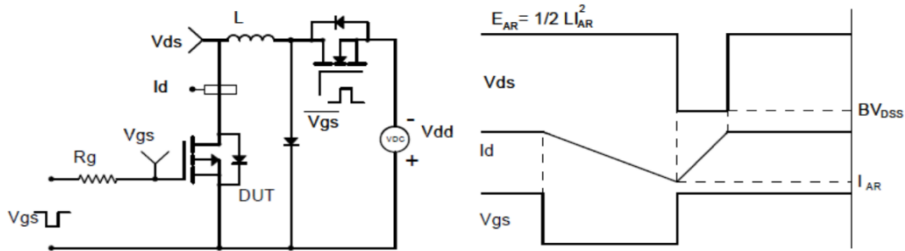


**Typical Characteristics**


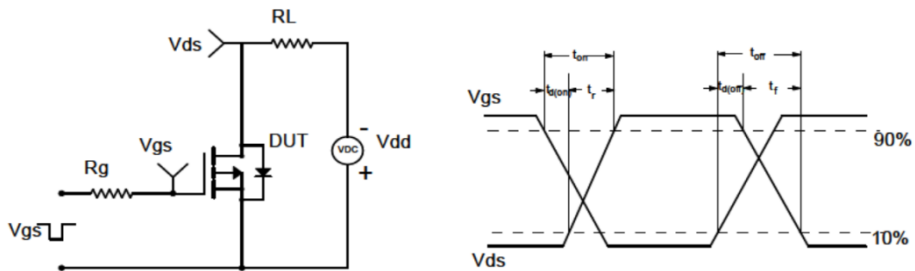
**Package Information**
**TO-252**


SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	2.200	2.300	2.400	0.087	0.091	0.094
A1	*	*	0.100	*	*	0.004
b	0.660	0.760	0.860	0.026	0.030	0.034
b3	5.130	5.295	5.460	0.202	0.208	0.215
c	0.470	0.535	0.600	0.019	0.021	0.024
D	6.000	6.100	6.200	0.236	0.240	0.244
D1	5.30 REF			0.20 REF		
E	6.500	6.600	6.700	0.256	0.260	0.264
E1	4.700	4.810	4.920	0.185	0.189	0.194
e	2.28 REF			0.09 REF		
H	9.800	10.100	10.400	0.386	0.398	0.409
L	1.400	1.550	1.700	0.055	0.061	0.067
L1	2.743 REF			0.108 REF		
L2	0.510 BSC			0.020 BSC		
L3	0.900	1.075	1.250	0.035	0.042	0.049
L4	0.600	0.800	1.000	0.024	0.031	0.039
$\theta$	0°	*	8°	0°	*	8°
$\theta 1$	5°	7°	9°	5°	7°	9°
$\theta 2$	5°	7°	9°	5°	7°	9°

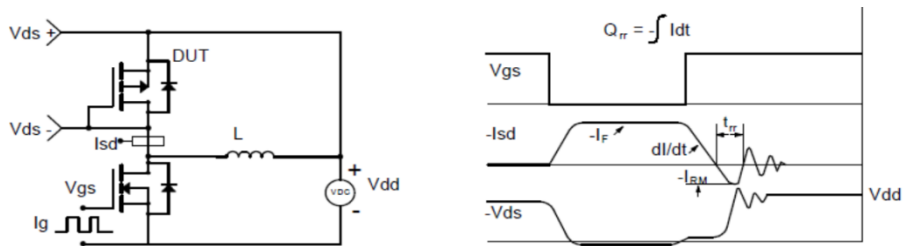
### Avalanche Test Circuit and Waveforms



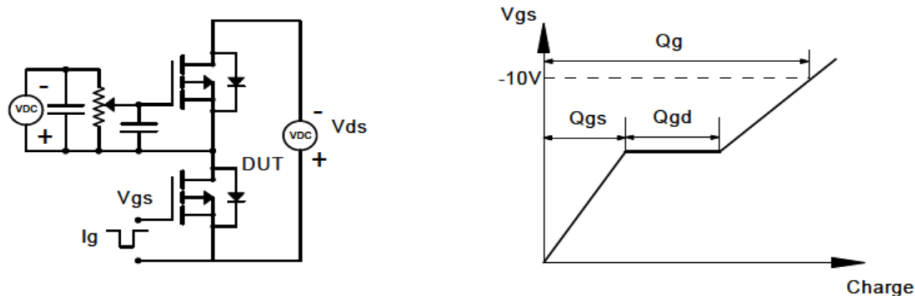
### Switching Time Test Circuit and Waveforms



### Diode Recovery Test Circuit and Waveforms



### Gate Charge Test Circuit and Waveform



### Customer Service

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